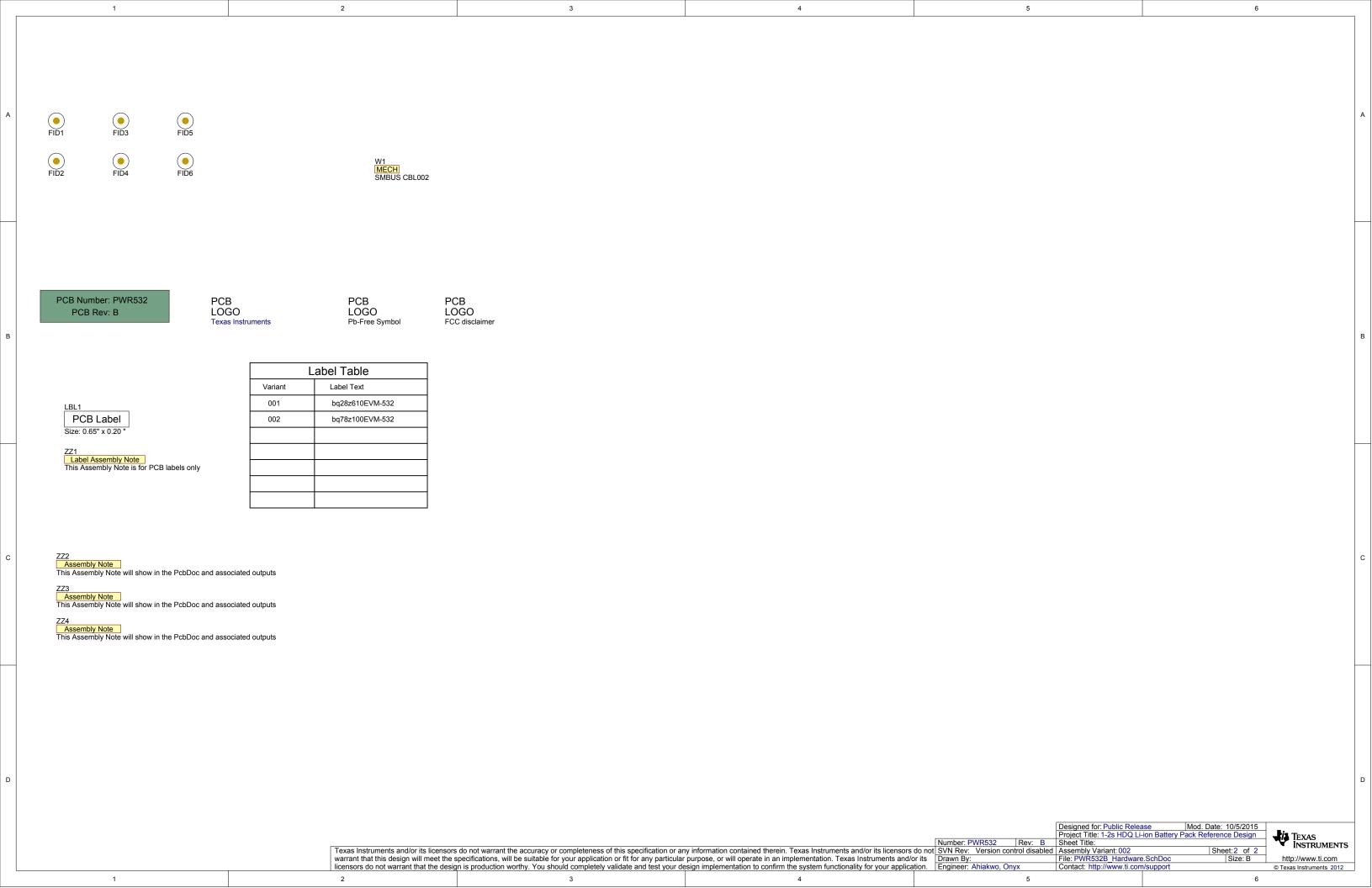


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Designed for: Public Release | Mod. Date: 1/27/2016 | Project Title: 1-2s HDQ Li-ion Battery Pack Reference Design | Number: PWR532 | Rev: B | Sheet Title: | SVN Rev: Version control disabled | Assembly Variant: 002 | Sheet: 1 of 2 | Drawn By:Onyx Ahiakwo | File: PWR532B.SchDoc | Size: C | Engineer: Ahiakwo, Onyx | Contact: http://www.ti.com/support | Size: C | Engineer: Ahiakwo, Onyx | Contact: http://www.ti.com/support | Contact: TEXAS INSTRUMENTS

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